ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information				
upplier Inform	ation														
Company name*			Company unique ID			J	Unique ID Authority				Respon	Response Date*			
nsemi										2024-04	2024-04-20				
Contact Name		Title - Contact			1	Phone - Contact*				Email -	Email - Contact*				
Product-Env-Stewa	rds	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized Represer	ntative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stewa	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester	Requester Item Number Mfr Ite		m Number Mfr Item Name				Effective Date	Date Version Manufacturing Site			Weight*	UOM	Unit Type		
		NCP5114	P51145MNTAG 1.8 Amp Source Sink VTT Regulator		ink VTT Term	ination	2024-04-20			MY1		9.61	mg	Each	
Ianufacturing I	Proccess Informati	on													
Terminal Plating / Grid Array Material Te			J-STD-020 MSI		L Rating	Peak Process Body Temperature   Max Time at Peal		k Temperature Number of Reflow Cycles							
Matte Tin (Sn) - annealed			CU Alloy 1			260	C 30		secoi	nds 3					
omments															
vel 1 - maximum ti	me at peak temperatur	e during sol	dering is 10-3	30 seconds											
or more informatio	n regarding material c	omposition	please refer to	page 3						·					

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct one bents it is form. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.27	mg	Supplier	Silicon (Si)	7440-21-3		0.27	mg
Die Attach	0.06	mg		Epoxy resin	proprietary data		0.0015	mg
			Supplier	Silver (Ag)	7440-22-4		0.0507	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0015	mg
			Supplier	Inorganic filler	Proprietary Data		0.0015	mg
			Supplier	Dicyandiamine	461-58-5		0.0003	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0045	mg
Lead Frame	3.71	mg	Supplier	Silver (Ag)	7440-22-4		0.0371	mg
			Supplier	Tin (Sn)	7440-31-5		0.0093	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0093	mg
			Supplier	Copper (Cu)	7440-50-8		3.6462	mg
Mold Compound-Black	5.0	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.4	mg
			Supplier	Carbon Black (C)	1333-86-4		0.025	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.325	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.15	mg
Plating	0.29	mg	Supplier	Tin (Sn)	7440-31-5		0.29	mg
Wire Bond - Au	0.28	mg	Supplier	Gold (Au)	7440-57-5		0.28	mg